

Coming Product in 2009

Preliminary

TDI Camera C10000-601,-701

Time Delay Integration Camera

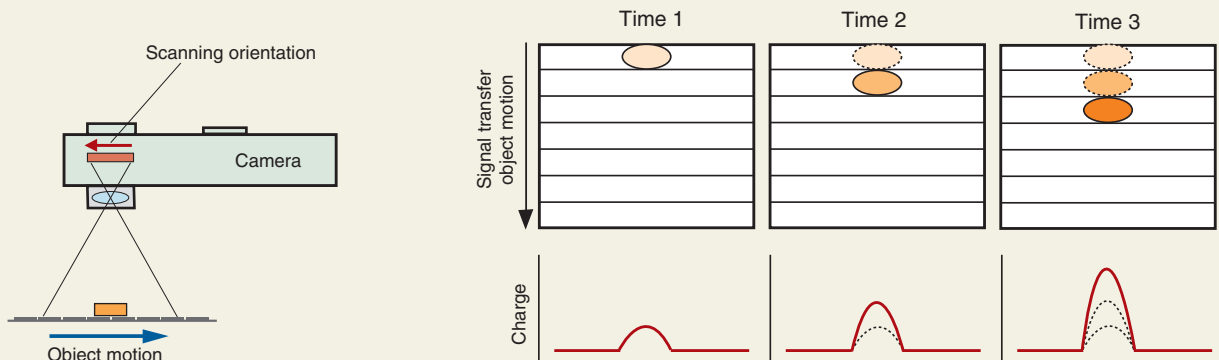


The C10000-601,-701 TDI camera is useful for a wide range of imaging applications requiring high speed operation with high sensitivity simultaneously. TDI is a special image acquisition method that has been used extensively in machine vision applications for industrial inspection. TDI imaging is appropriate for applications where it is desired to record a linear process over time, or where the aspect ratio of the subject being imaged is significantly asymmetric. TDI is particularly useful for low light level scanning applications for which a typical line scan camera can not make a useful image. Also, frame readout mode is available for easy focusing.

OPERATING PRINCIPLE OF TDI

TDI (Time Delay Integration):

Time Delay Integration is a technology of scanning in which a frame transfer device produces a continuous video image of a moving object by means of a stack of linear arrays aligned with and synchronized to the motion of the object to be imaged in such a way that, as the image moves from one line to the next, the integrated charge moves along with it, providing higher resolution at lower light levels than is possible with a line-scan camera.



FEATURES

- **High resolution / high sensitivity**
(Horizontal spatial resolution with 128(V) TDI stages)
- 4096(H) × 128 (V) , 16 TAP or 8 TAP
- **Line rates up to 100 kHz**
(C10000-701, 16 TAP with 30 MHz pixel clock)
- **High speed imaging combined with high sensitivity and low noise**
- **Great spectral response for UV-NIR with back thinned CCD**
- **100 % fill factor**
- **100× anti-blooming with lateral overflow drain**
- **Dynamic range of 800 : 1 (C10000-601,-701B)**
- **12 bit / 8 bit selectable A/D converter (C10000-601)**
- **Bi-directional scanning operation**
- **Frame readout mode for easy focusing**
- **Internal real-time shading correction**

APPLICATIONS

- **High speed imaging for low light applications i.e. fluorescence imaging**
- **Electronics manufacturing and inspection**
- **Semiconductor inspection**
- **High speed scanning for a large size sample i.e. flat panel displays**

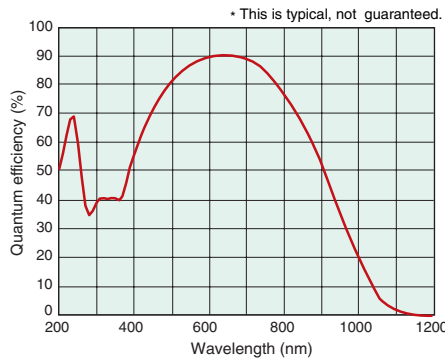
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SPECIFICATIONS

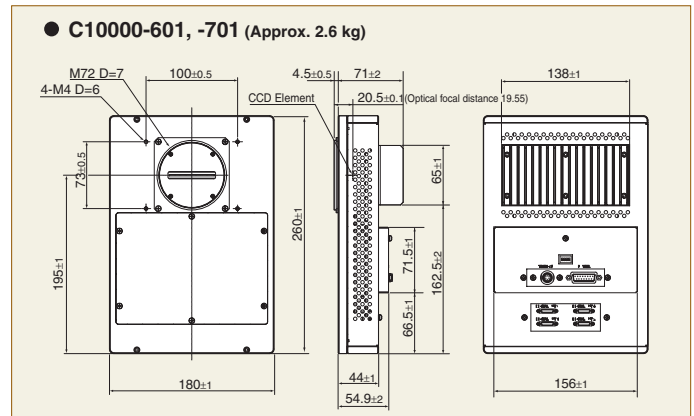
Type number	C10000-601	C10000-701A	C10000-701B
Pixel number	4096 (H) × 128 (V)		
Device structure	Back thinned type		
Cell size	12 μm(H) × 12 μm(V)		
Effective area	49.16 mm(H) × 1.536 mm(V)		
Readout mode	TDI readout mode or frame readout mode*1		
TDI transfer direction	Bi direction		
TDI output channel	8 TAP (512 × 8)		16 TAP (256 × 16)
Anti-blooming	Lateral overflow drain (100×)		
TDI pixel clock rate	30 MHz		
TDI line rate	0.45 kHz to 50 kHz		0.45 kHz to 100 kHz
TDI line rate control	Internal setting by serial command*2 / External trigger		
Full-well capacity (typ.)	80 000 electrons		
Readout noise (typ.)	100 electrons r.m.s. *3		
Dynamic range (typ.)	800 : 1	256 : 1	800 : 1
Binning	2 × 2		
Analog enhancement gain	1 time to 5 times (16 steps)		
A/D converter	12 bit / 8 bit *4	8 bit	12 bit
Image processing	Internal real-time shading correction / Background subtraction		
Interface	Medium Configuration	Full Configuration ×1	Medium Configuration ×2
Camera control	Serial control in Camera Link		
Camera output clock	60 MHz		
Camera output channel	4 TAP (1024 × 4)		8 TAP (512 × 8)
Camera Link connector	Mini-Camera Link (SDR) × 2	Mini-Camera Link(SDR)× 2	Mini-Camera Link(SDR)× 4
Lens mount	M72, P=0.75		
Power / Power consumption	DC +12 V / 36 W		
Ambient storage temperature	-10 °C to +50 °C		
Ambient operating temperature	0 °C to +40 °C		
Ambient operating / storage humidity	70 % max. (with no condensation)		

*1 Frame readout mode is useful for easy focusing, but it is not suitable for measurement. Please consult with our sales office for details.
 *2 Internal TDI line rate is set by 33 ns step. *3 Provisional figure *4 Selectable by DIP switch.

SPECTRAL RESPONSE

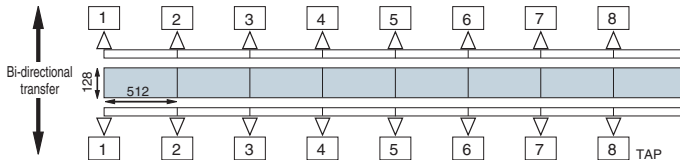


DIMENSIONAL OUTLINES (Unit : mm)

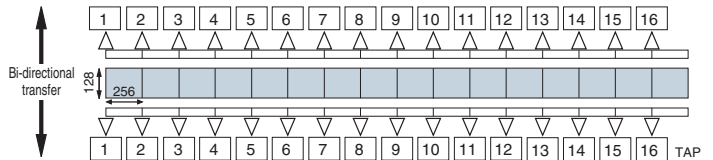


TDI SENSOR STRUCTURES

* C10000-601 (4096×128, 8 TAP)



* C10000-701 (4096×128, 16 TAP)



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